	l	501-115131-3-NEFONT] Nev. A					
TE SHANG	HAI ELECTRICAL COMPONENTS	REPORT No.: 501-115131-3					
connectivity	TEST LABORATORY	PROJECT No.: PRJ-16-000910715					
	_	STARTED: 2016-11-23					
TEST	REPORT	COMPLETED: 2017-02-10					
		ISSUED:					
CUSTOMER INFORMATION	l:	SPECIMEN INFORMATION:					
Name: Consumer Devices		Description: High current spring finger					
Request by: Ji, Jone	Ji, Jone Part No.: 2306654-*						
Request Date: 2016-11-23		Qty.: 35 pcs					
Address: No.668 Guiping Ro	ad Shanghai. China.	Received Date: 2016-11-23					
DISPOSED OF SAMPLES:	Keep in lab						
DESCRIPTION: 1.8H spring finger. See Fig1, total 35pcs samples were used for 7 test groups.							
	requirements for product performance, test						
resting was performed at TE	Connectivity Snangnai Electrical Test Labo	ratory between Nov 23, 2016 and Feb 10, 201					

TEST PERFORMED:

See test sequence (page 2) and test procedure (page 4& page 5).

SPECIFICATION:

108-115120.

CONCLUSION:

See the summary of test result.

DISTRIBUTION: Applicant

PREPARED BY: Dong Zhihua
Test Engineer

CHECKED BY: Wu Hellen
Test Supervisor

APPROVED BY: Lu Robin
Test Manager

CLASSFICATION: Class 2

APPENDICES: See Appendix.

Page 1 of 3 Rev A

^{© 2014} Tyco Electronics Corporation, a TE Connectivity Ltd. company. All Rights Reserved. Test report shall not be reproduced except in full, without written approval of the laboratory.



SHANGHAI ELECTRICAL COMPONENTS TEST LABORATORY

501-115131-3

TEST PURPOSE

This is product qualification test. The purpose of this test is to evaluate the performance of High current spring finger connector. Testing was performed on below products to determine it compliance with the requirements of 108-115120.

TEST SEQUENCE

	Test Group									
Test Item	1	2	3	4	5	6	7			
	Test Sequence									
Examination of Product	1,5	1,3	1,6	1,5	1,5	1,3	1,5			
Normal force Test	3,6		2,7							
LLCR			3,5	2,4	2,4		2,4			
Temperature Rising						2				
Temperature Life			4							
Thermal Shock					3					
Humidity Temp. Cycling				3			3			
Durability test	4									
Resistance to Soldering Heat	2									
Solderability Test		2								

SUMMARY OF TEST RESULTS

Group	Test Item	N	Condition	Test Result			Poquiroment	Conclusion	
Споир				Max	Min	Ave	Unit	Requirement	Conclusion
	Examination of Product 5 Initial No physical damage		N/A	No abnormalities	Meet Spec				
	Resistance to Soldering Heat	5	Initial	Initial No physical damage		N/A	No abnormalities	Meet Spec	
4	Normal force Test	5	Initial	0.74	0.67	0.70	Ν	0.4N Min.	Meet Spec
1	Durability test	5	Final	No physical damage			N/A	No abnormalities	Meet Spec
	Examination of Product 5 Final No physical damage		mage	N/A	No abnormalities	Meet Spec			
	Normal force Test	5	Final	0.72	0.67	0.69	N	0.4N Min.	Meet Spec
	Examination of Product	5	Initial	No physical damage		N/A	No abnormalities	Meet spec	
2	Solderability Test	5	Final	Soldering Coverage greater than 95%		N/A	95% Min.	Meet Spec	
	Examination of Product	5	Final	No physical damage		N/A	No abnormalities	Meet Spec	
	Examination of Product	5	Initial	No physical damage		/	No abnormalities	Meet Spec	
	Normal force Test	5	Initial	0.77	0.72	0.745	N	0.4N Min.	Meet Spec
	LLCR	5	Initial	43.0	40.3	41.8	mΩ	50 mΩ Max.	Meet spec
3	Temperature Life	5	Final	No physical damage		N/A	No abnormalities	Meet Spec	
	LLCR	5	Final	46.9	41.3	44.5	mΩ	50 mΩ Max.	Meet Spec
	Examination of Product	5	Final	No physical damage		N/A	No abnormalities	Meet Spec	
	Normal force Test	5	Final	0.70	0.64	0.67	N	0.4N Min.	Meet spec

TE Proprietary & Confidential Information

© 2014 Tyco Electronics Corporation, a TE Connectivity Ltd. company . All Rights Reserved.

Test report shall not be reproduced except in full, without written approval of the laboratory.

TE Connectivity Shanghai Electrical Components Test Laboratory.

Tel: 86-21-33259340 Fax: 86-21-33259224 Post Code: 200233 Address: No.668 Guiping Road Shanghai, China.

Page 2 of 3 Rev A



SHANGHAI ELECTRICAL COMPONENTS TEST LABORATORY

501-115131-3

							I	l NI-	
	Examination of Product	5	Initial	No physical damage			N/A	No abnormalities	Meet spec
	LLCR	5	Initial	46.5	31.3	39.2	mΩ	50 mΩ Max.	Meet Spec
4	Humidity and Temperature Cycling	5	Final	No physical damage			N/A	No abnormalities	Meet Spec
	LLCR	5	Final	46.1	29.1	39.1	mΩ	50 mΩ Max.	Meet Spec
	Examination of Product	5	Final	No physical damage			N/A	No abnormalities	Meet Spec
	Examination of Product	5	Initial	No physical damage		N/A	No abnormalities	Meet spec	
	LLCR	5	Initial	42.8	40.4	41.4	mΩ	50 mΩ Max.	Meet Spec
5	Thermal Shock	5	Final	No physical damage			N/A	No abnormalities	Meet Spec
	LLCR	5	Final	45.5	40.5	43.5	mΩ	50 mΩ Max.	Meet Spec
	Examination of Product	5	Final	No physical damage			N/A	No abnormalities	Meet Spec
	Examination of Product	5	Initial	No physical damage		N/A	No abnormalities	Meet spec	
6	Temperature Rising	5	Final	11.3	8.8	10.4	°C	30°C Max.	Meet Spec
	Examination of Product	5	Final	No physical damage		N/A	No abnormalities	Meet Spec	
	Examination of Product	5	Initial	No physical damage		N/A	No abnormalities	Meet Spec	
	LLCR	5	Initial	43.5	39.6	41.1	mΩ	50 mΩ Max.	Meet spec
7	Humidity and Temperature Cycling	5	Final	No physical damage		N/A	No abnormalities	Meet spec	
	LLCR	5	Final	43.2	41.2	42.2	mΩ	50 mΩ Max.	Meet spec
	Examination of Product	5	Final	No physical damage			N/A	No abnormalities	Meet spec

ENVIRONMENTAL CONDITION

Unless otherwise stated, the following environmental conditions prevailed during testing: Temperature:15°C to 35°C, Relative Humidity: 25% R.H to 75% R.H

TEST SPECIMEN

Assembly

Name	P/N	Qty.	Manufacturer
1.8H spring finger	2306654-*	35	TE

------ END OF REPORT-----

TE Proprietary & Confidential Information

© 2014 Tyco Electronics Corporation, a TE Connectivity Ltd. company . All Rights Reserved. Test report shall not be reproduced except in full, without written approval of the laboratory.

TE Connectivity Shanghai Electrical Components Test Laboratory.

Tel: 86-21-33259340 Fax: 86-21-33259224 Post Code: 200233 Address: No.668 Guiping Road Shanghai, China.

Page 3 of 3 Rev A